Test Module VPM&DGFT&24Bit

Shear Test- Ball/Die						
Transducer	Auto Rar	nge				
S250G	250g	100g	50g	25g		
S500G	500g	250g	100g	50g		
S1KG	1000g	500g	250g	100g		
S5KG	5000g	2500g	1000g	500g		

Pull Test-Wire					
Transducer	Auto Ran	ge			
WP25G	25g	10g	5g	2.5g	
WP50G	50g	25g	10g	5g	
WP100G	100g	50g	25g	10g	
WP1000G	1000g	500g	250g	100g	

Specifications						
Footprint Weight Power Supply Pneumatic Supply Vacuum Supply OS System Accuracy		Depth 1300mm, Width 1280mm, Heigth 1650mm (excluding alarm tower) 1200kg 110V / 220V AC @ 16A 50/60Hz CDA, 0.4MPa - 0.6MPa < - 60KPa Win10 64Bit ± 0.1%FS				
Axis	X/Y axis travel X/Y axis accuracy X/Y axis maximum speed X/Y axis maximum force Z axis travel Z axis accuracy Z axis maximum speed Z axis maximum speed Z axis maximum force	200 mm X 150 mm ± 5 um 50 mm/s 20kgf 70mm ± 1um 5mm/s 20kgf				
XY Tables	XYS2015 XYS3220 XYS3215	200 mm X 150 mm maximum force: 20kgf 320 mm X 200mm maximum force: 20kgf 320 mm X 150mm maximum force: 100kgf				
Specification of the Loader& Unloader	Width Length Model Configuration of loading and unload	35mm - 100 mm 120mm - 300mm Single-step / Fully automatic ading Standard A in B out Optional A in A out				
Test Mode	Semi-automatic Fully automatic	As the industry leader in the field of bond testing, TRY-PRECISION supplies automatic, semi-automatic multi-function bond tester and material				
Software	ABT2000C SECS/GEM(Optional)	tester with advanced technology and superior performance in long-term for semiconductor integrated circuit and microelectronics assembly industry.				
Compliance	EMC RoHS CE	wning lots of advanced core technologies, perfect market and service vstem. TRY-PRECISION also can provide deep technical support and ficient after-sales service so as to offer both high-quality products and ervices for global semi-conductor enterprises.				

Specifications subject to change without prior notice.

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ABT2000C **Bond Tester**



Advanced Automatic Testing Technology

Fully Automatic & Unmanned Operation & Multi-function Bond Tester

Magazine To Magazine Fully Automatic Loader & Unloader

I_see Intelligent Image Recognition

Advanced Dynamic Force Measuring System

High Accuracy Positioning Control Technology

Advanced Automatic Loader & Unloader



Automatic Magazine Loader



Automatic Lead-frame Loader & Unloader



Automatic Lead-frame Carrier and Clamper



- Users Put the Magazine into the Loader & Unloader, Select the Recipe, the System Automaticly Running, Include the Whole Process Steps: Lead-Frame Loading / PR / Dynamic Force Measuring / Data Analysis / Data Uploading / Lead-Frame Unloading etc.
- Multiple Magazine Load, Batch Testing, None Manual Operation for the Same Type Magazine(Lead-frame)
- Adjustable Magazine Clamper
- Adjustable Loading & Unloading Rail
- Adjustable Lead-frame carrier and clamper
- Automatic & High Accuracy Positioning Lead-frame Clamper
- Automatic Magazine Loading Monitor, Loader Alarm When None Magazine or Empty Magazine is Full.
- Automatic Lead-frame Loading & Unloading Monitor

I_SEE Intelligent Image Recognition

- With the intelligent image recognition system in 3 levels, it is equipped with powerful camera and optical system to achieve intelligent recognition and positioning, which is with high accuracy and repeated positioning accuracy.
- Trinocular microscope and HD camera, facilitate observation operation and test video recording, and assist customer test and analysis.
- Friendly man-machine operation interface, powerful software function with high performance.





High-precision cameras, optical lens



Intelligent visual recognition software

Advanced Automatic Bond Testing System

- With the high dynamic sensor and VPM patented technology, it can achieve the accurate positioning of the test principal axis without any excursion.
- With the vector shear test module, the test angle can be automatically rotated according to the characteristics of the samples, and the vector shear can be realized through multi-axis linkage of the system.
- ±0.1%FS system accuracy and 24Bit ultrahigh resolution to ensure excellent measurement repeatability



Friendly Human-machine Interaction

- Powerful, convenient operation, supporting multiple mode
- Manual and automatic test mode switchable, match mass production test requirements
- With four-level management authority, match control requirements of users:
- With complete data processing, analysis, statistics and other functions, supporting SECS / GEM, MES and other third-party interfaces and transmission;
- Support software one-step control; visual device status display



Applications



Semiconductor Automotive Electronics







SMT

Power Semiconductor